

MRED Update

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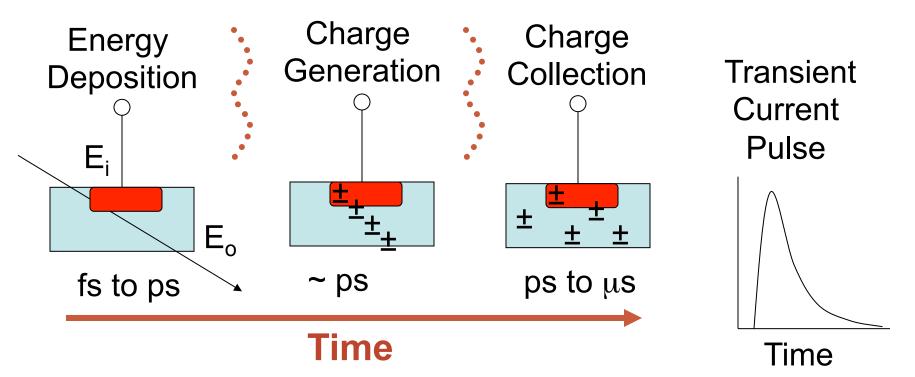




Outline

- Radiation-Induced Single Event Effects
- MRED: Monte Carlo Radiative Energy Deposition
- Review of some of the applications
 - Contribution of Ion-Ion nuclear reactions to SEU rates
 - SEU from low energy proton
 - Muon-induced SEUs
 - Single-electron SEUs
- Conclusions

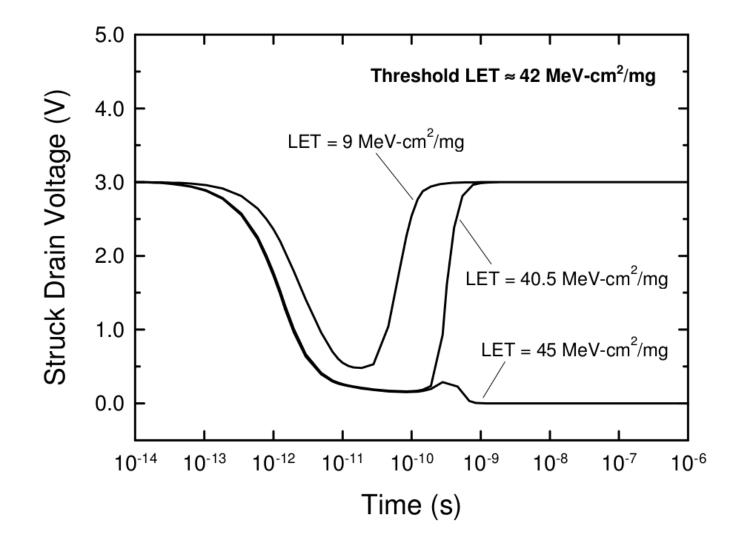
Transients from Single Particle Event



Soft Error Examples:

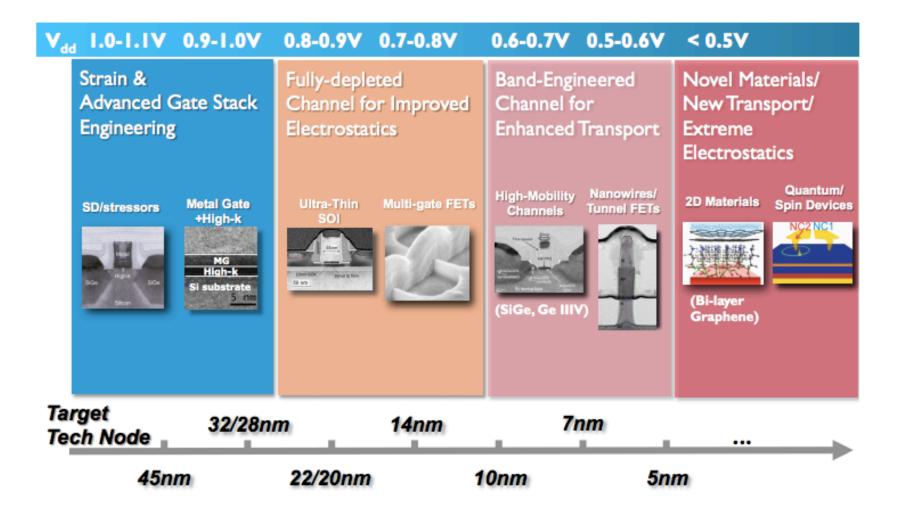
- Single Event Transient: A current pulse occurring at a circuit node due to single energetic particle event
- Single Event Upset: A change in a circuit's logic state induced by a single energetic particle event

Impact of Ion LET on SEU Response



Dodd NSREC SC 2001

Electronic Technology Roadmap



MRED

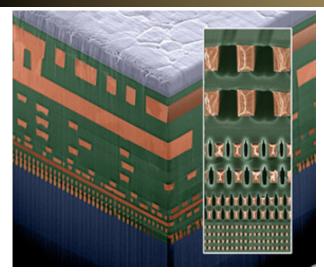
- MRED is a Python-language scriptable computer application that simulates radiation transport
- The MRED code integrates selected physics processes associated with the Geant4 toolkit with Fortran codes PENELOPE 2008, an electron transport code, and CEM03 and LAQGSM [7-9], both nuclear physics codes
- Papers that describe MRED:
 - Weller, R., Mendenhall, M. H., Reed, R., et al. (2010). "Monte Carlo simulation of single event effects." *Nuclear Science, IEEE Transactions on*, *57*(4), 1726-1746.
 - Reed, R., Weller, R., et al. (2015). "Physical processes and applications of the Monte Carlo radiative energy deposition (MRED) code." Accepted for publication in TNS.
 - Reed, R. A., Weller, R., et al. (2013). "Anthology of the development of radiation transport tools as applied to single event effects." *Nuclear Science, IEEE Transactions on*, 60(3), 1876-1911.

CREME

- CRÈME is a tool suite for predicting radiation environments and it's effects on electronics
 - Selected environment models for trapped, solar, and GRC
 - Contains analytical and Monte Carlo models for SEU rates
 - <u>https://creme.isde.vanderbilt.edu</u>
- MRED is the computational engine for the on-line Monte Carlo tool CRÈME-MC
 - Monte Carlo simulation of energy deposition in selected volumes
 - Ground tests
 - Event rates

MRED Applications (2005 - 2015)

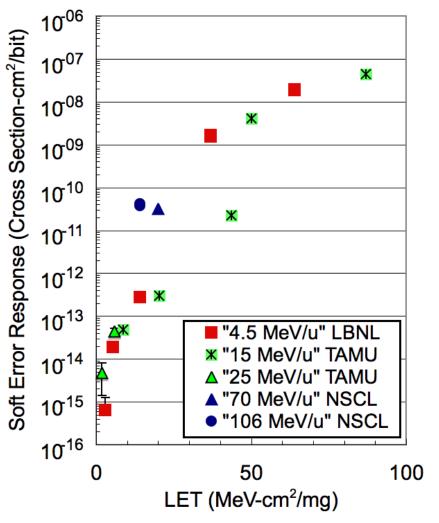
Ion-Ion Reactions



http://images.dailytech.com/nimage/4621_21476.jpg

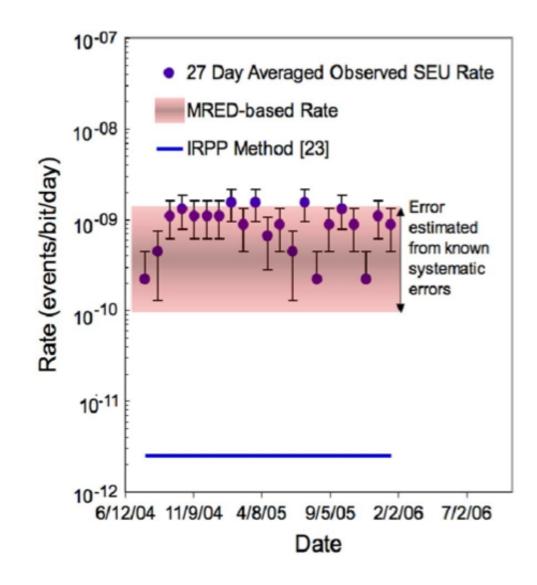
- Multi-valued cross section at same LET
 - CS = upset / fluence
- Ion-Ion nuclear reactions in non-silicon material near the sensitive volume contribute to the soft error response

Experimental evidence for this effect on a CMOS SRAM



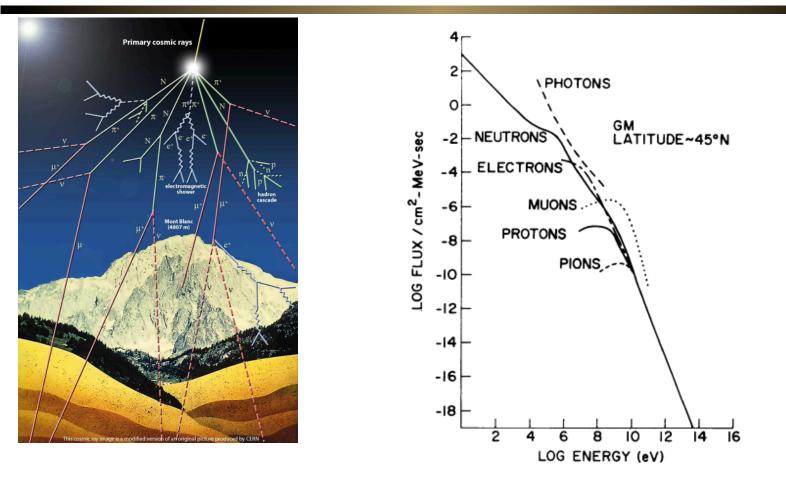
Warren et al. 2005, Dodd et al., TNS 2007, Reed et al. TNS 2007

Event Rate and Ion-Ion Nuclear Reactions



Warren et al. 2005, Dodd et al., TNS 2007, Reed et al. TNS 2007

Terrestrial Environment

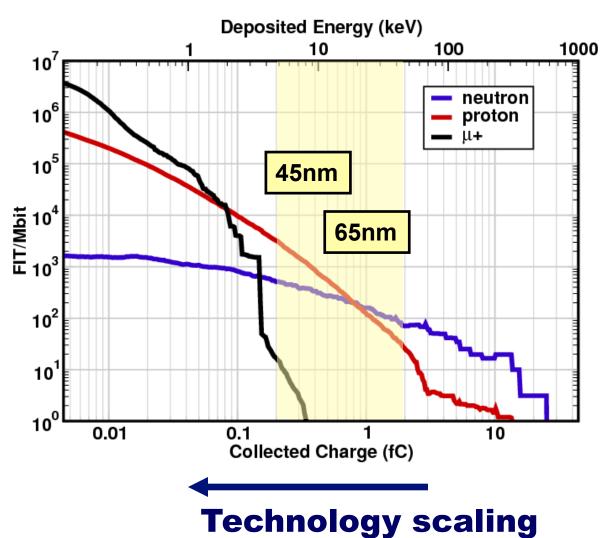


- Cosmic rays create showers ("zoo") of secondary particles in the atmosphere
- Neutrons, while numerous, rarely interact with material leading to single event upsets
- Muons are the most abundance particle at sea level —Stopping power similar to protons

Sierawski, TNS 2010

Preliminary Simulations (circa 2009)

- MRED Monte Carlo simulations indicated potential for upset from muon direct ionization
- Technology scaling (assuming same sensitive volume dimensions) will increase susceptibility to terrestrial protons, muons
- Spectra will be moderated by concrete, buildings, etc.

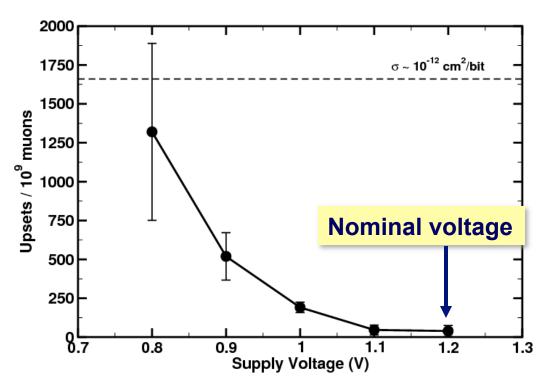


Single Event Upsets 65 nm SRAM

 Reduced bias experiments explored dependence on critical charge

Q = CV

 Few errors observed at nominal operating point, large increase for minimum functional voltage

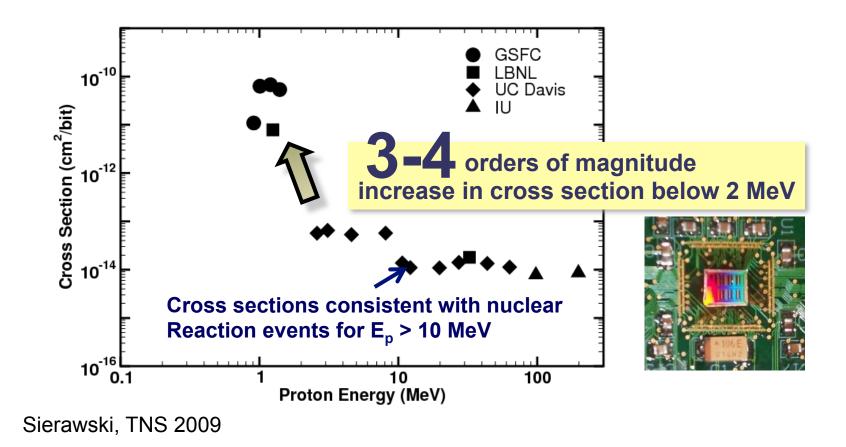


 Bias is a possible indicator for susceptibility at the next technology node

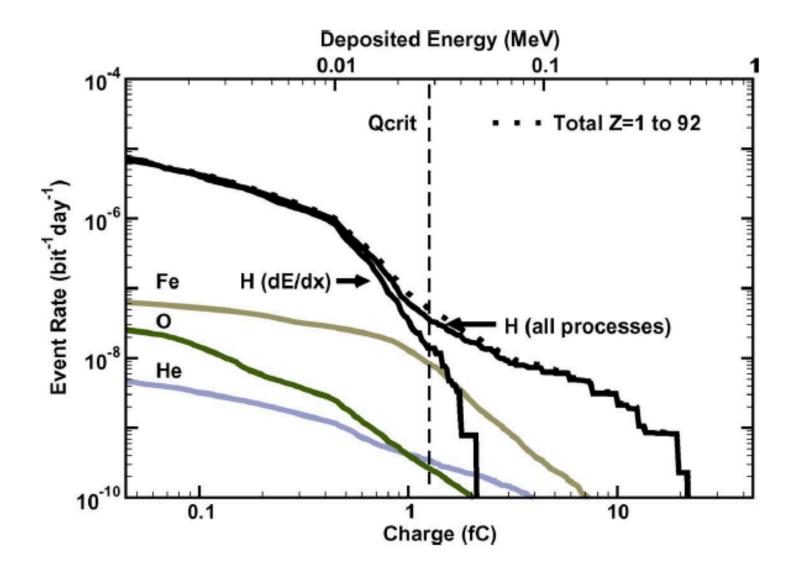
•Geometric effects still need to be considered

Low-Energy Proton Upsets

- Previous work reported data collected by Vanderbilt and NASA Goddard on TI 65 nm bulk CMOS process [Sierawski, TNS 2009]
- Consistent with evidence of proton direct ionization contributing to single event upsets (SEUs) reported for IBM 65 nm SOI process [Rodbell, TNS 2007][Heidel, TNS 2008]



Low-Energy Proton Upsets



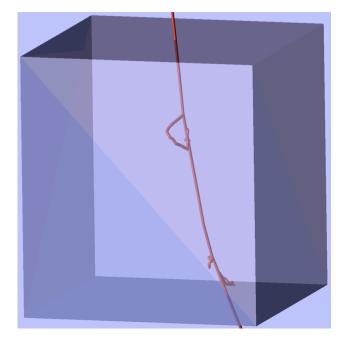
Single Electron-Induced SEU (circa 2010)

- Critical charge estimates for 22 nm on the order of 0.1 fC – 0.35 fC at nominal supply voltage
- Devices are becoming increasingly sensitive to lightly ionizing particles
 - Low-energy Protons
 - Muons

MRED simulations suggested electrons can deposit energy in excess of critical charge estimates

- 2.6 keV or 0.12fC

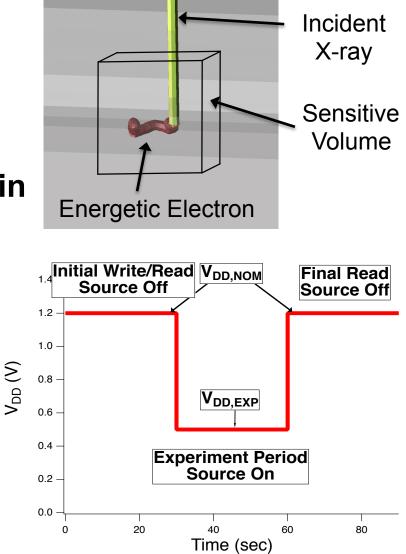
10 keV electron



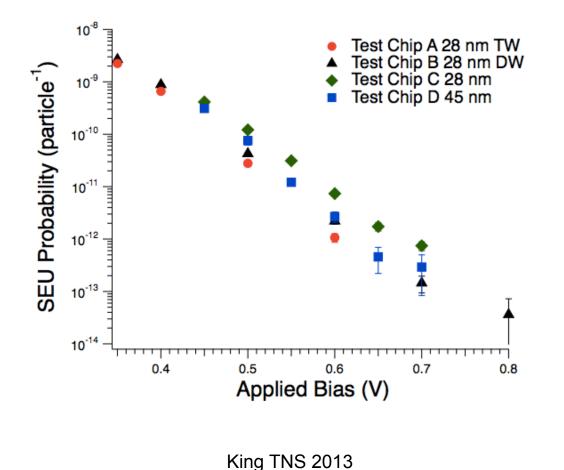
50 nm Cube

Experimental Method – X-ray Irradiation

- 28 nm and 45 nm SRAMs
- X-rays used to generate secondary energetic electrons
- Dose rate of 100 rad(SiO₂)/min
- Reduced bias testing
- Devices were designed and verified experimentally to be functional at all supply voltages used in this experiment



Upsets in 28 & 45 nm SRAMs



SEU probability

$$Pr(V_{DD}) = \frac{N}{M} \frac{1}{A_{cell} \Phi}$$

- Eliminated TID, photocurrents, and functionality as source of observed errors
- No significant parametric degradation; power supply current stable

Electron Irradiation

- Arnold Engineering Development Center
- Space Threat Assessment Testbed (STAT)
- Electrons, protons, photons, and others

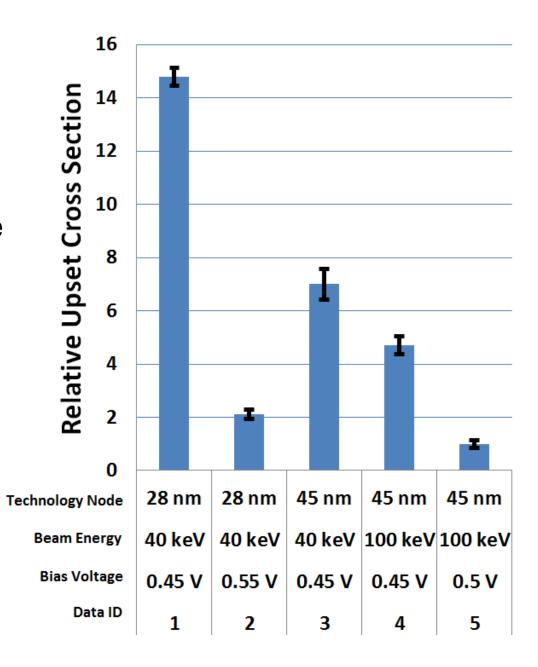




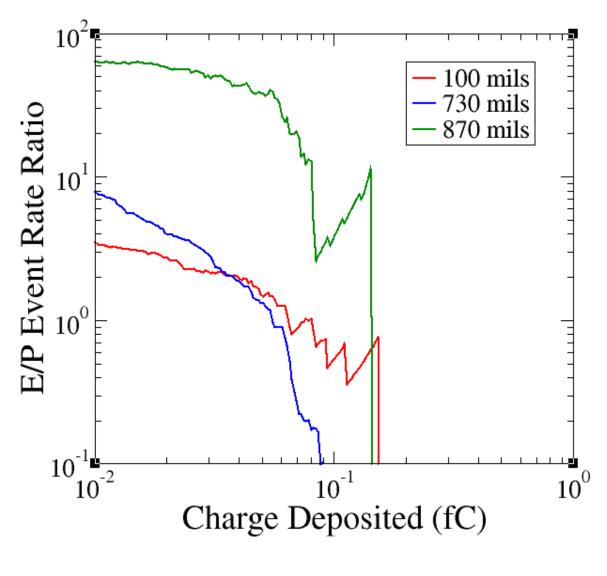


Electron Irradiation Results

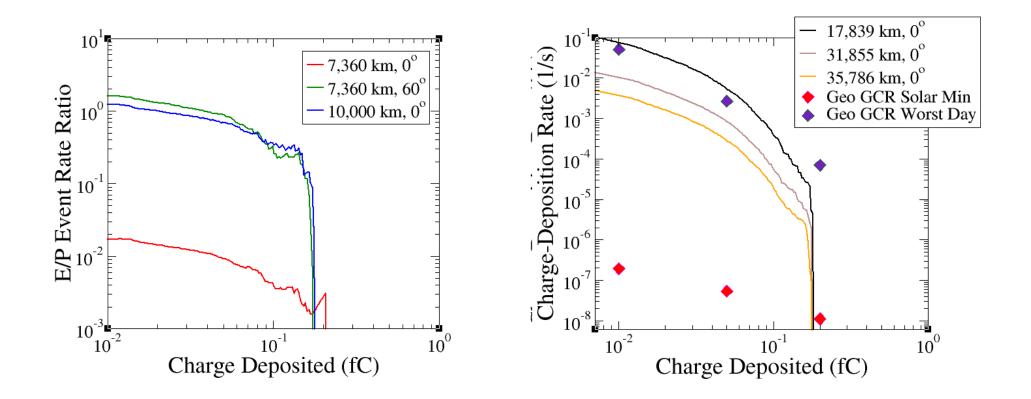
- All data normalized to Data ID #5
- Relative cross section increases with reduced bias and smaller technology node
- This provides significant evidence that these upsets were caused by single electron effects
- These trends are consistent Te with previous experiments with low energy protons and muons Trippe TNS 2015

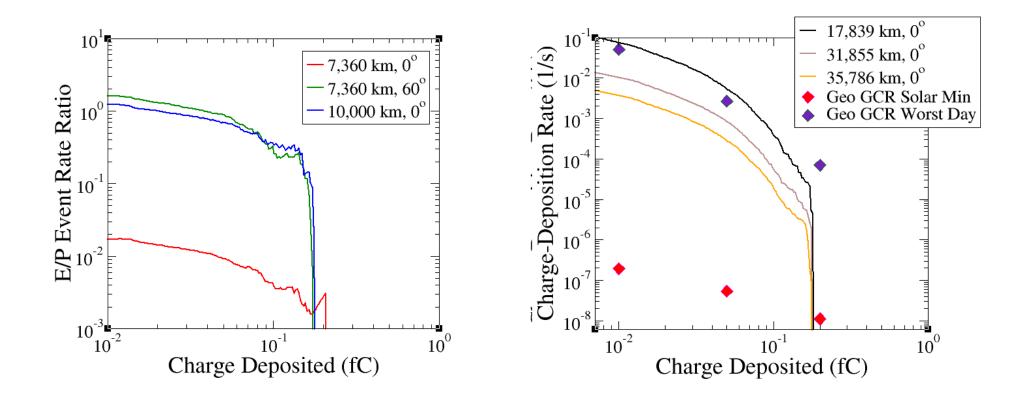


Rate Predictions – Europa orbit



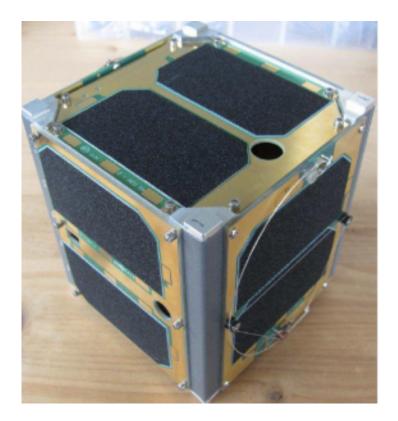
Trippe TNS 2015





CubeSat

- Radiation effects experiments
- Vulcan
 - SRAM SEU (65nm)
 - Launch Oct 2015
- Independence
 - SRAM SEU (65 nm)
 - Latchup test
 - Launch Oct 2015
- RadFxSat
 - SRAM SEU test (28 nm)
 - Launch Nov 2016



Conclusions

- MRED development is frozen at the current version with no future updates planned
- Application of MRED continues
 - Research new effects
 - Solving engineering problems
- CRÈME website maintenance and user support is funded by NASA Electronic Parts and Packaging Program